

# Development of Innovative Insulation Systems on the Basis of Vacuum Insulation Panels

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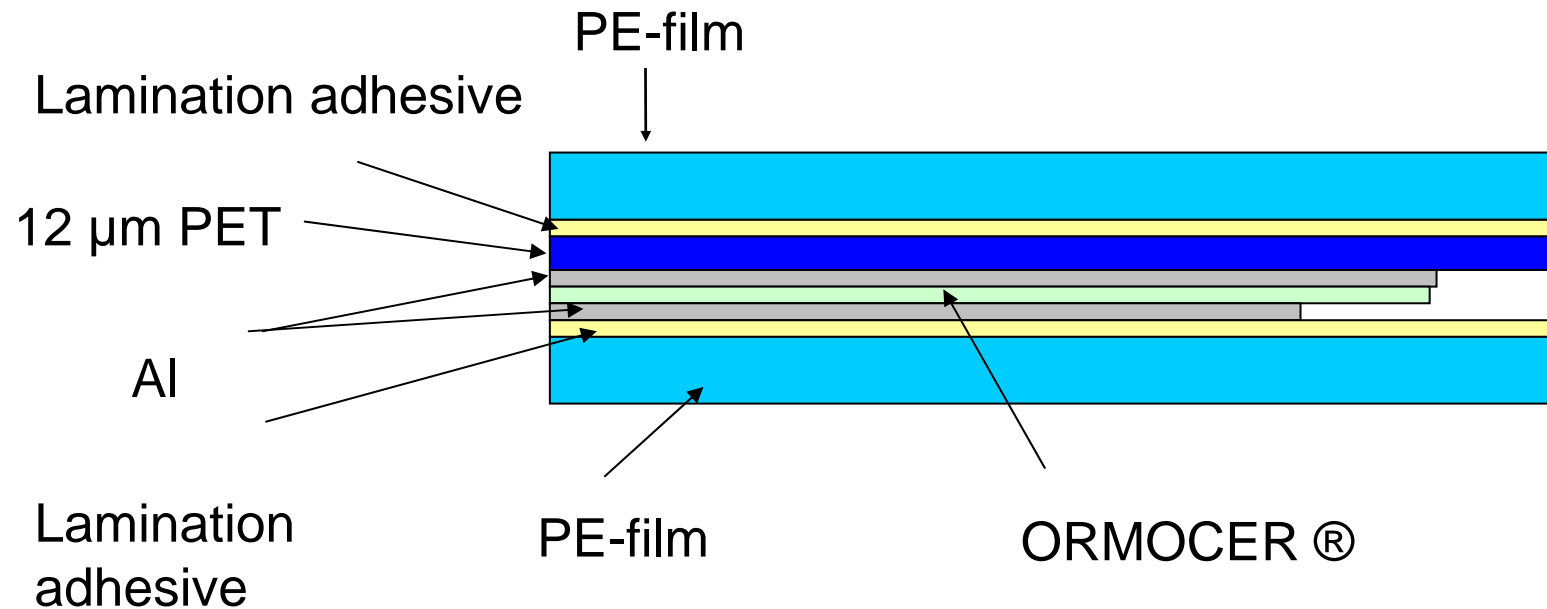
# Overview

- Barrier film development
- Influence of panel production on barrier films
- Heat flux measurements and simulation
- Design of exterior wall insulation system
- Evaluation and monitoring
- Conclusions



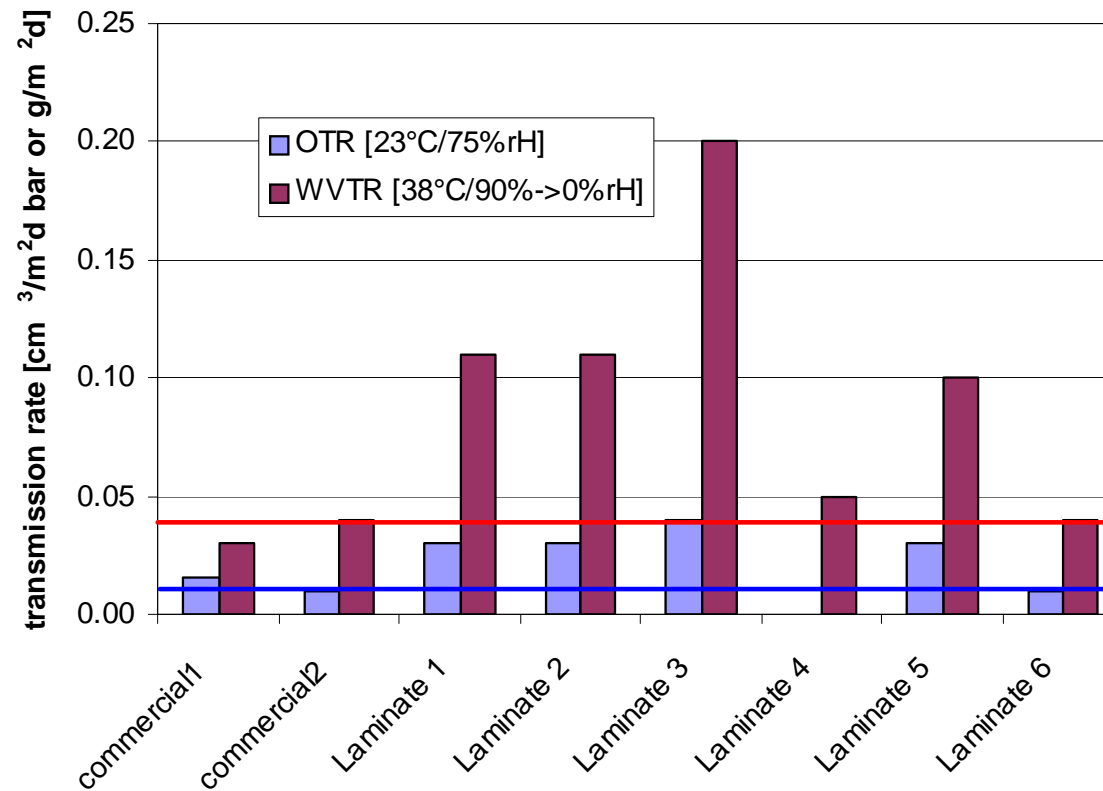
# Barrier Film Development

- Alternative Layer composition





# Results from prototype laminates



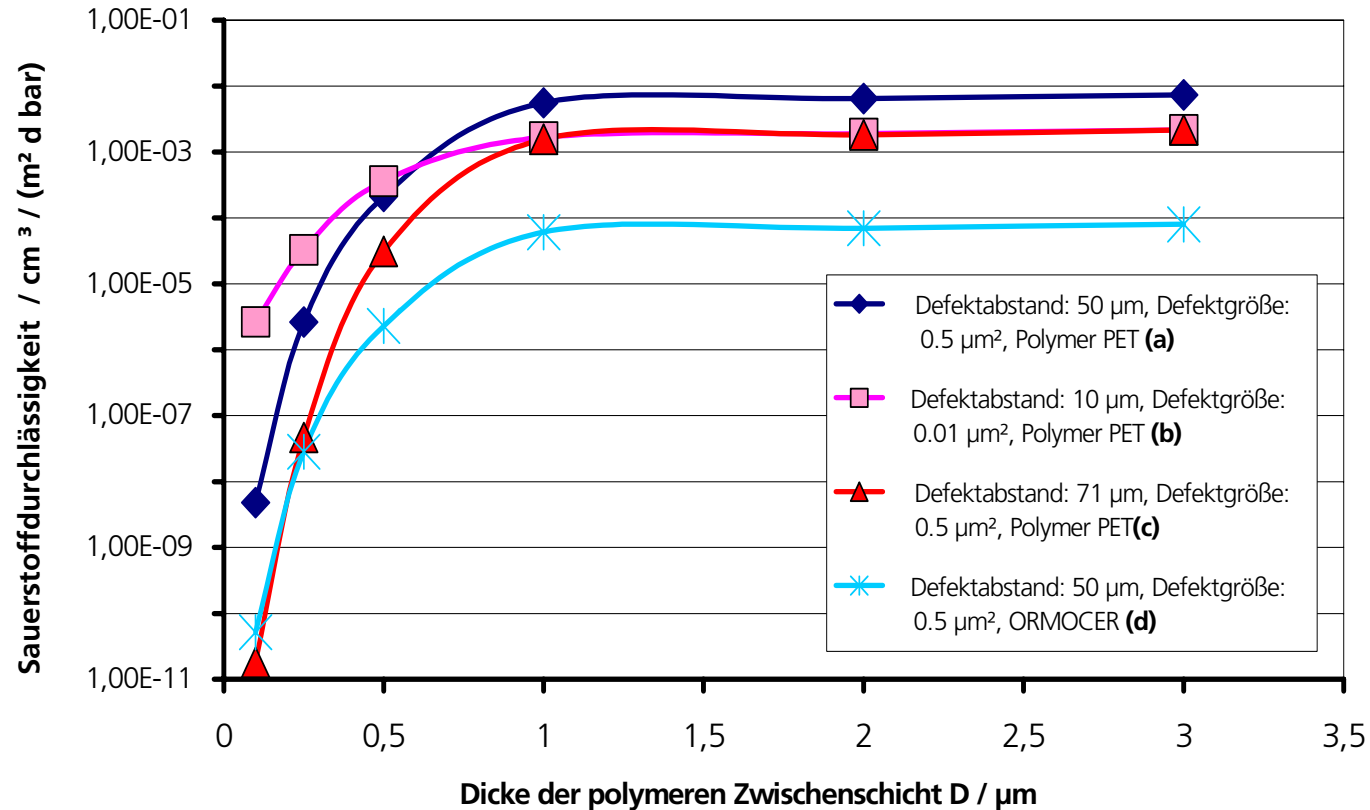
## Potential of optimisation

- Increase of aluminum layer thickness
- Change of standard lacquer Ormocer® 08 against further developed lacquers used already within the project in other tests
- Reduction of Ormocers® layer thickness

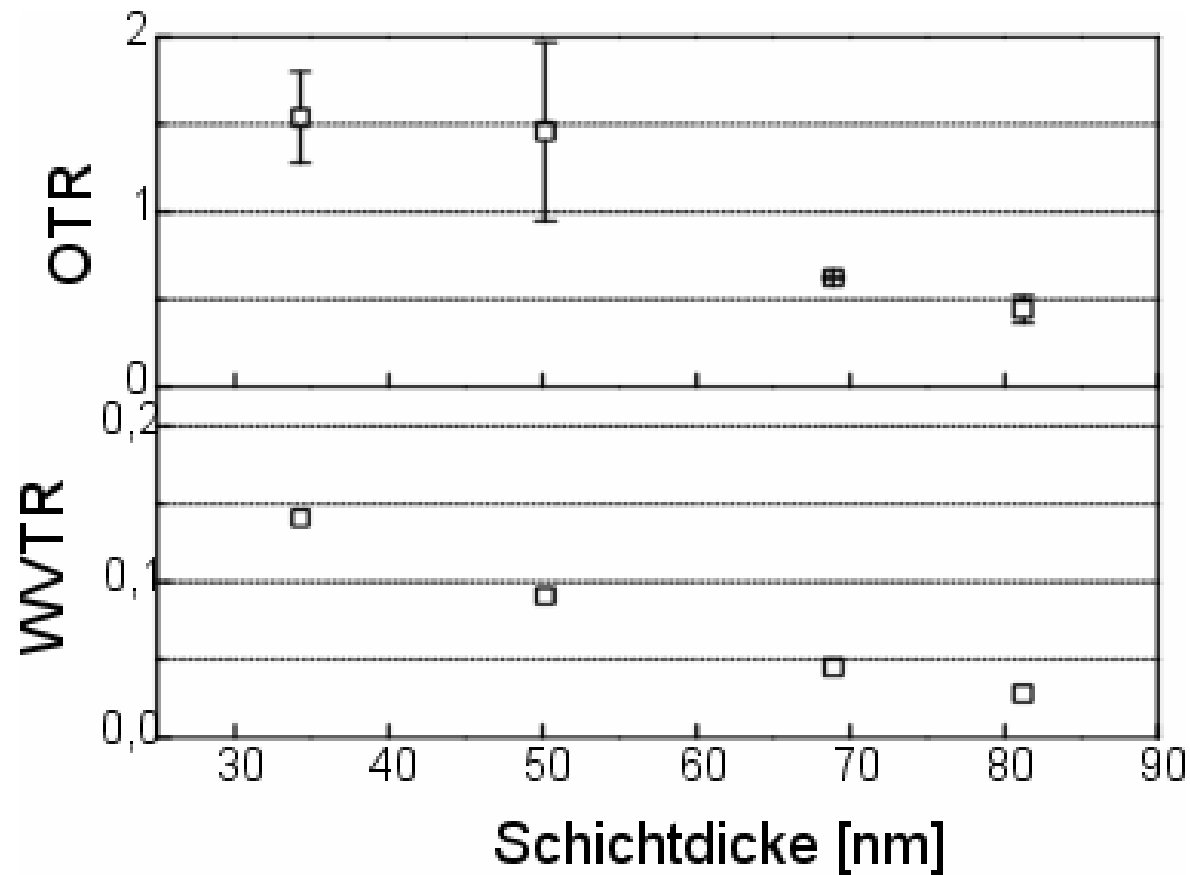
=> expected consequence:  
improvement of 1-2 orders of magnitude



# Theoretical Simulation Ormocer Layer Thickness



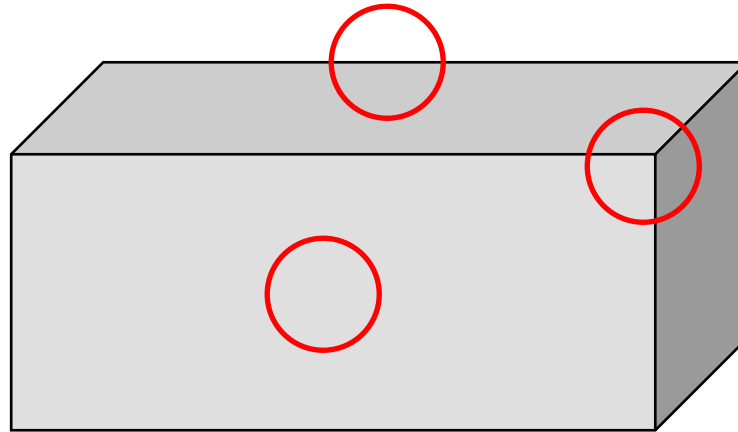
# Influence of Aluminum Thickness





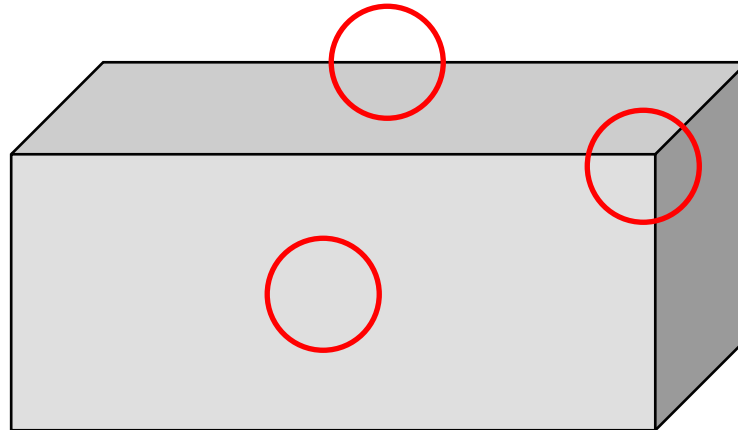
## VIP Panel characterisation

- Films were cut from different positions of a thin (10mm) and a thick (20mm) VIP panel
- OTR and WVTR were determined
- 3 commercial films used for panel production



## VIP Panel characterisation results

- Depending on film deterioration of film properties in corners and edges was observed
- worst case more than factor 10 deterioration in corners  
best case still factor 4 deterioration for WVTR
- no significant difference between thin and thick panels



## Panel heat transport

- Linear thermal conductance

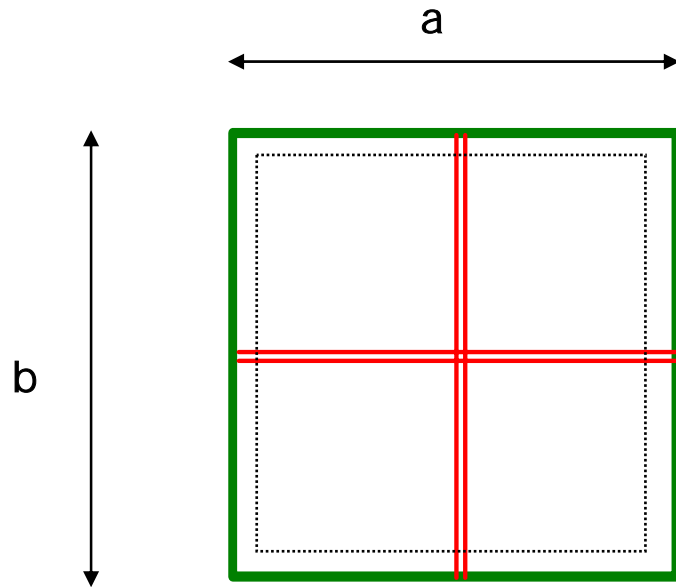
$$U = U_0 + \frac{\Psi \cdot L}{A}$$

- Contributions from two panels

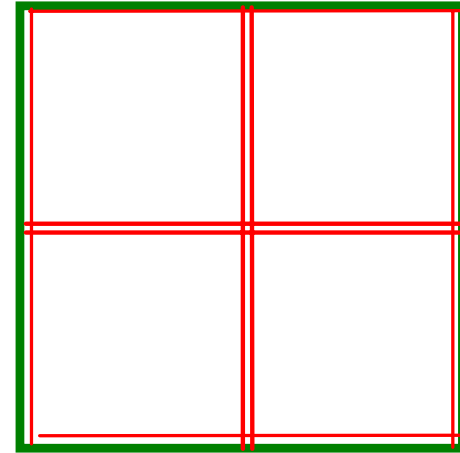
$$\Psi = 2 \cdot \Psi_{1/2}$$



# Panel heat transport



$$U_{meas} = U_0 + \frac{2 \cdot (a + b) \cdot \Psi_{1/2}}{a \cdot b}$$

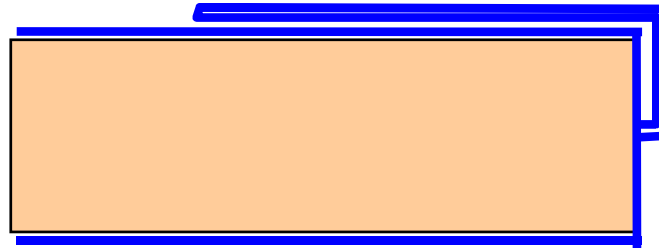


$$U_{avg} = U_0 + \frac{4 \cdot (a + b) \cdot \Psi_{1/2}}{a \cdot b}$$

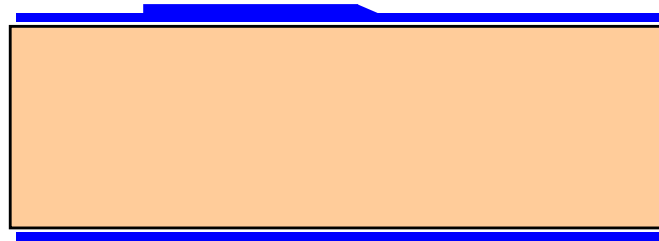


# Testing of different VIP types

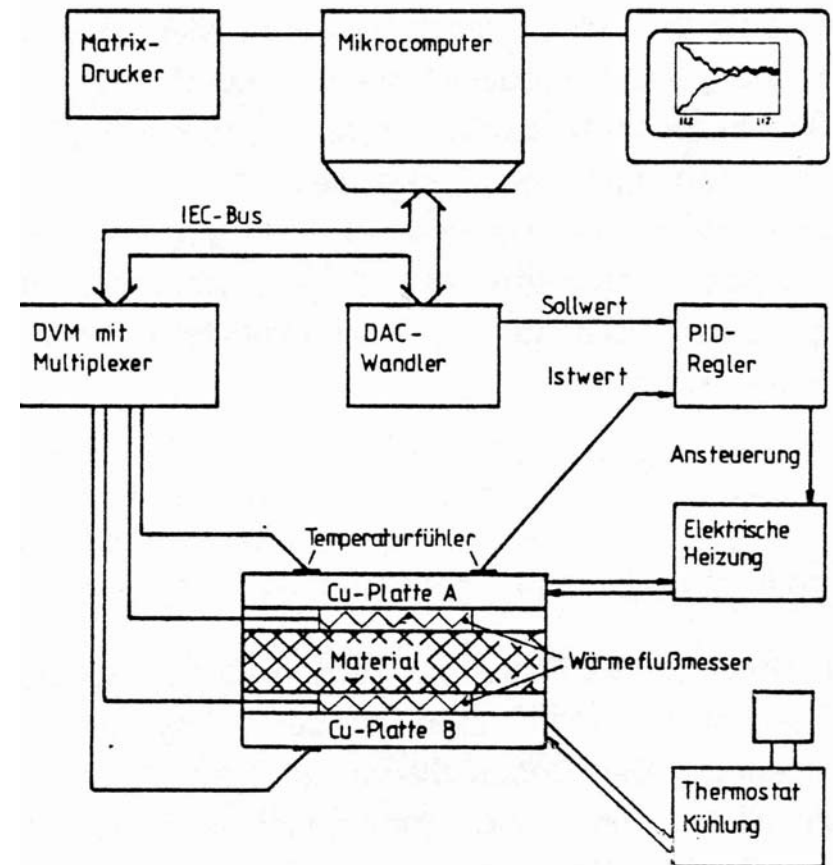
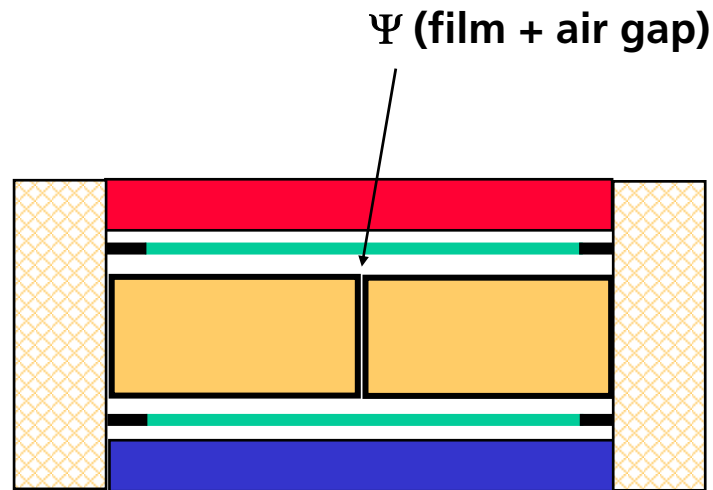
- Type VIP1



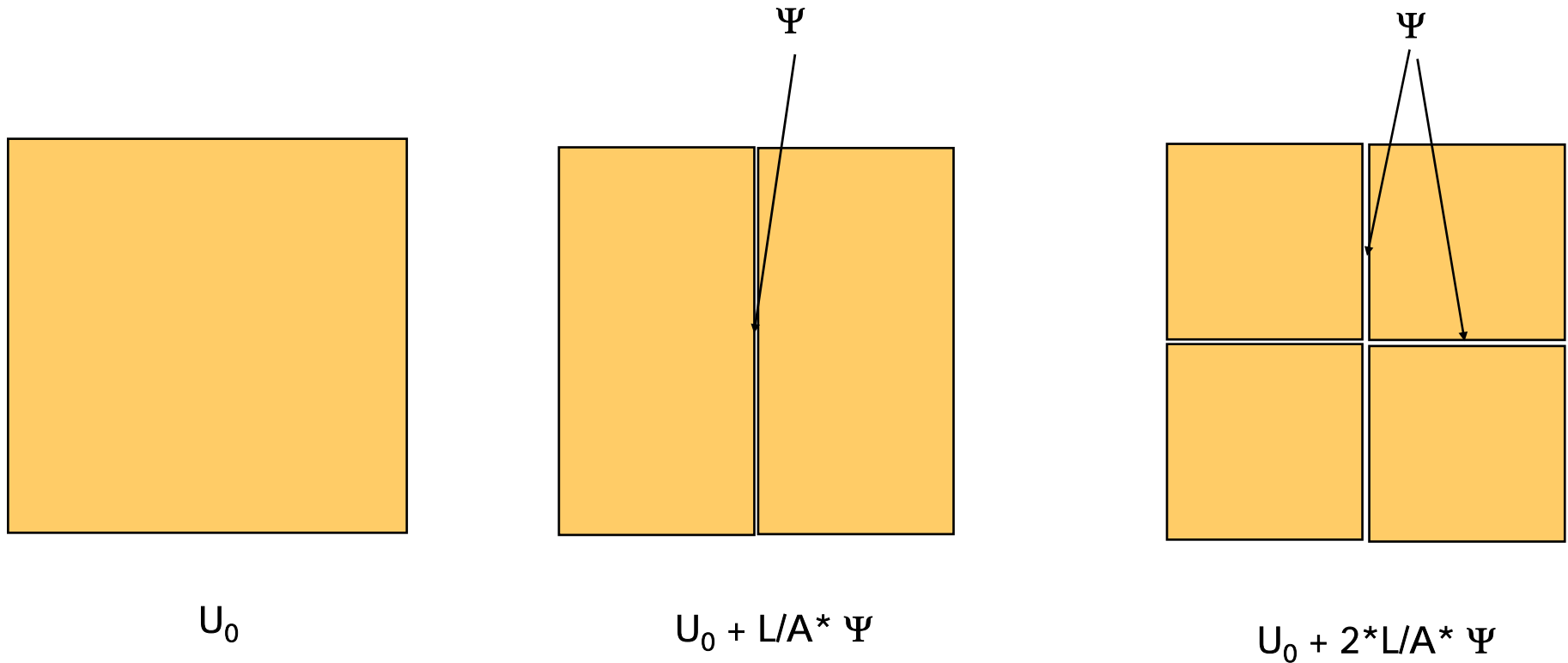
- Type VIP2 with reduced thermal bridge



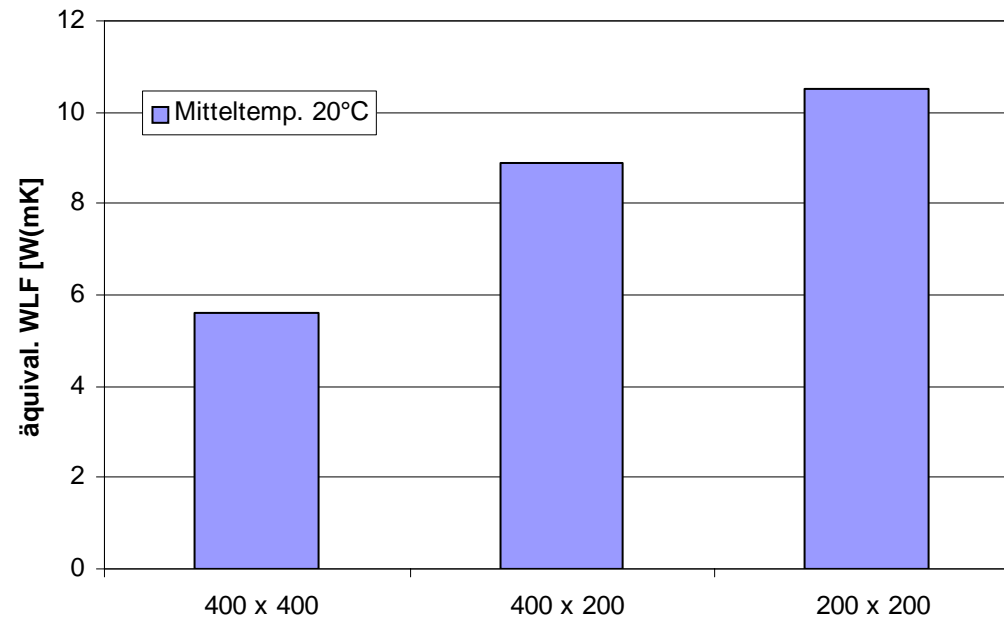
# Hot-plate apparatus using heat flux meters



# Testing of VIPs with different sizes



# Measurement results (VIP1)

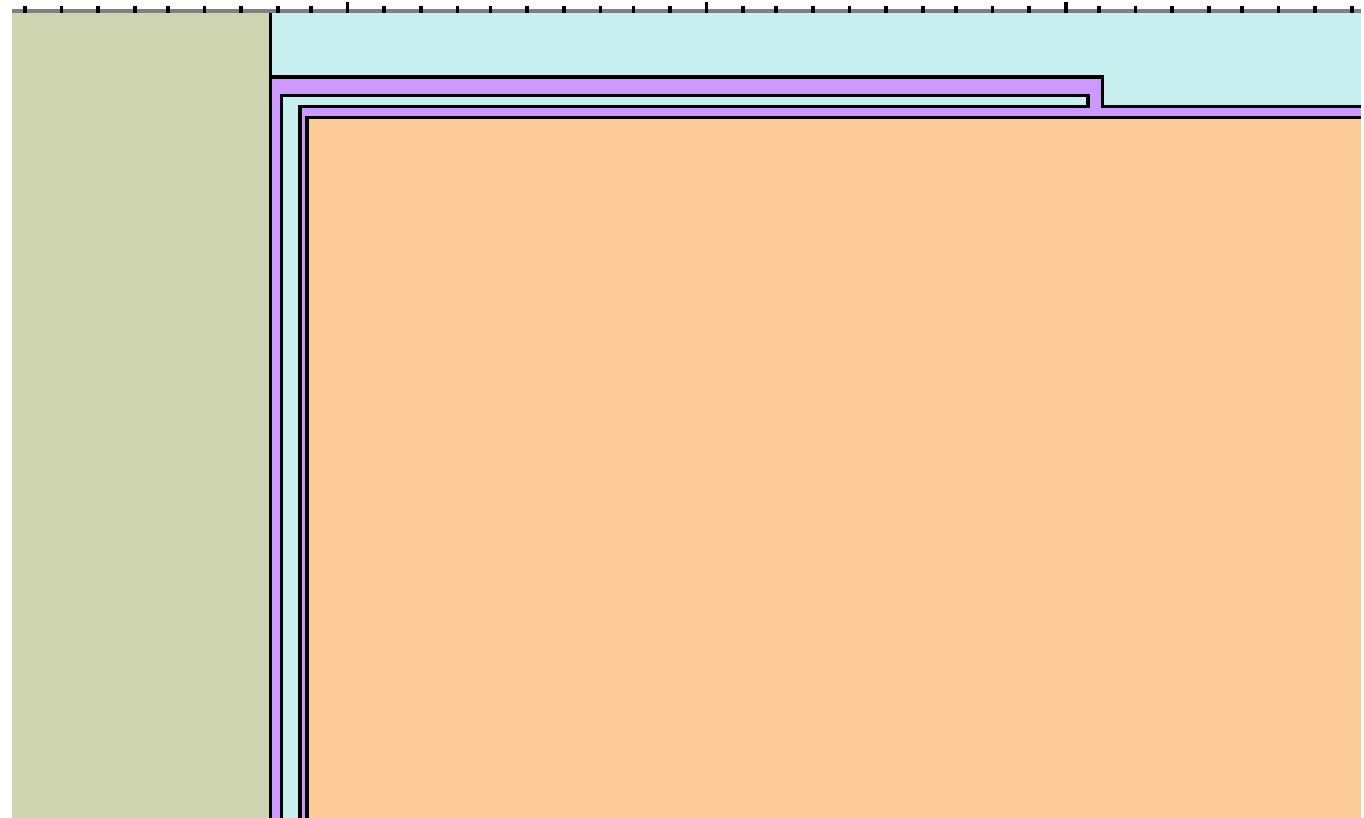


$$\Psi = ( 0.052 \pm 0.010 ) \text{ W/mK}$$

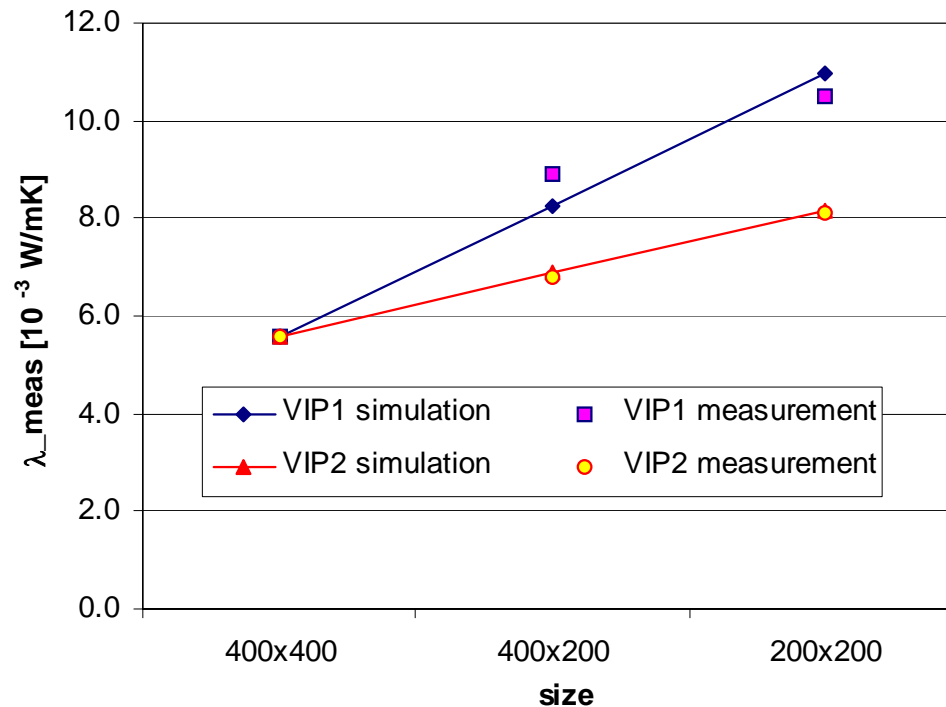




# Simulation of folding ears



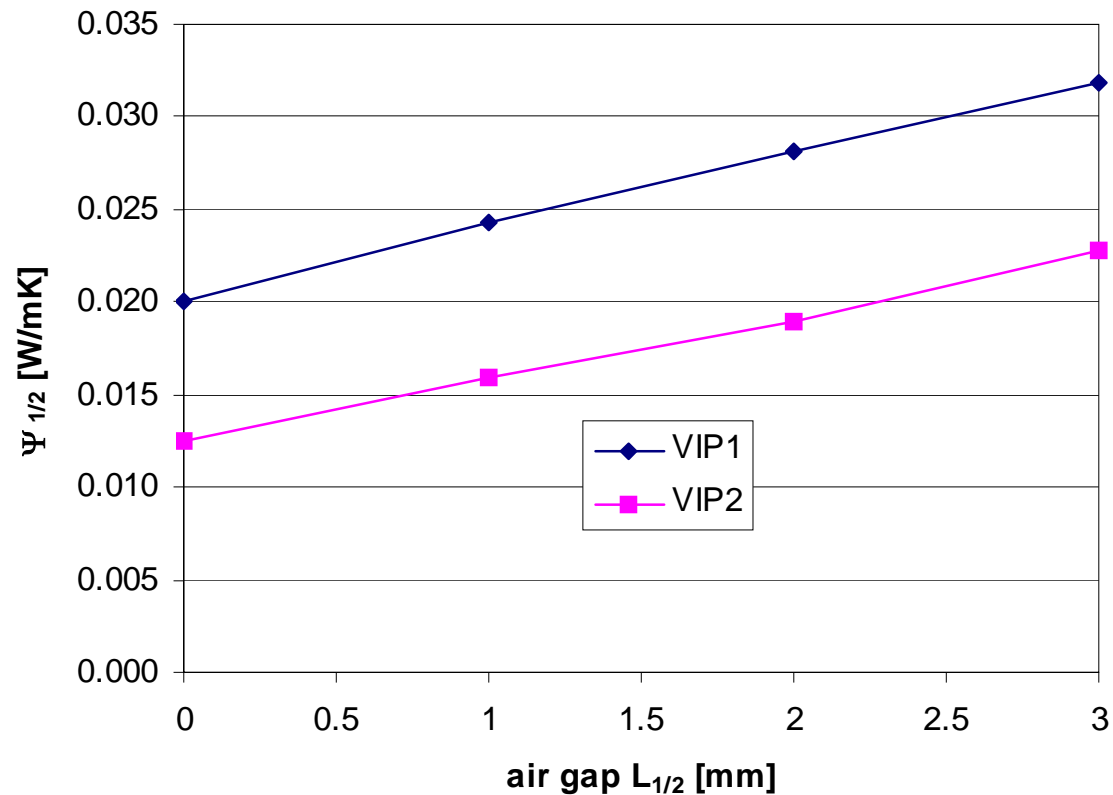
# Calibration of simulation film conductivity



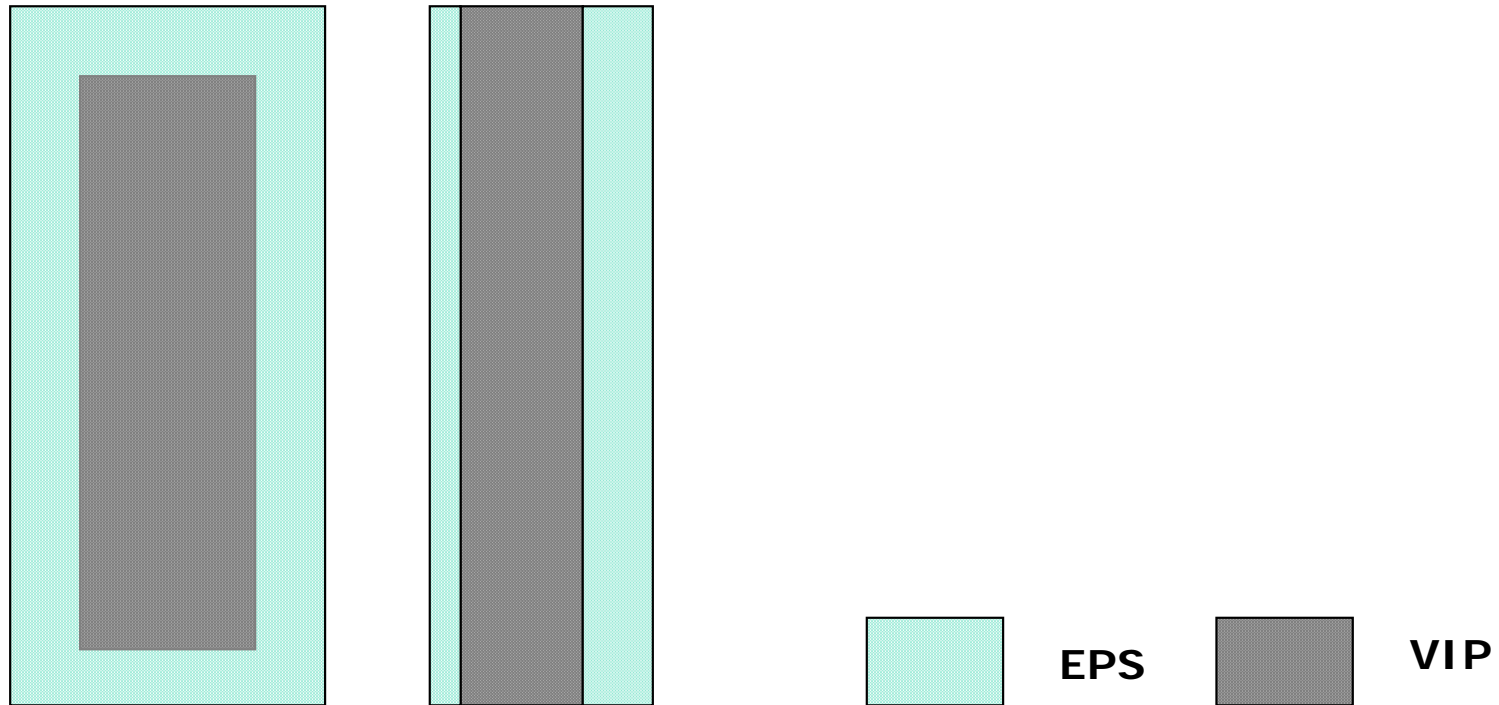
$$\lambda_{\text{eff}} (100\mu\text{m}) = (1.5 \pm 0.4) \text{ W/mK}$$



# Results of thermal simulation



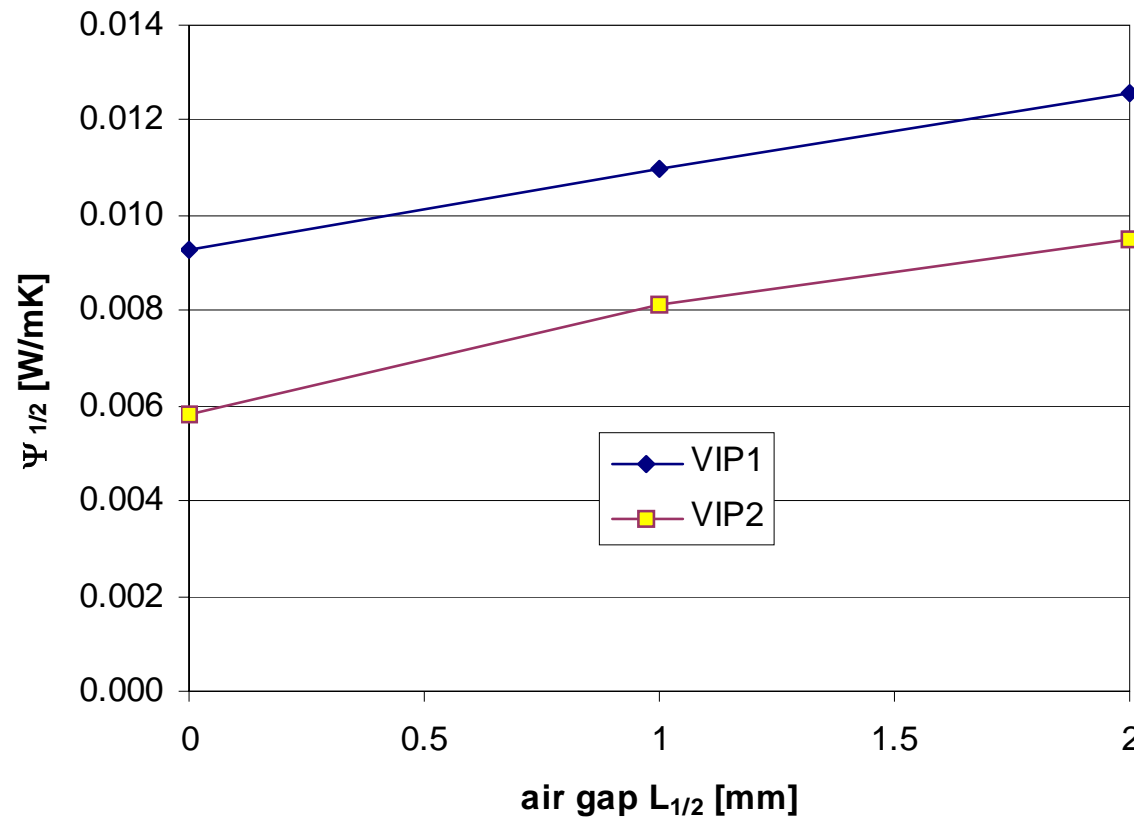
# Design of exterior wall system



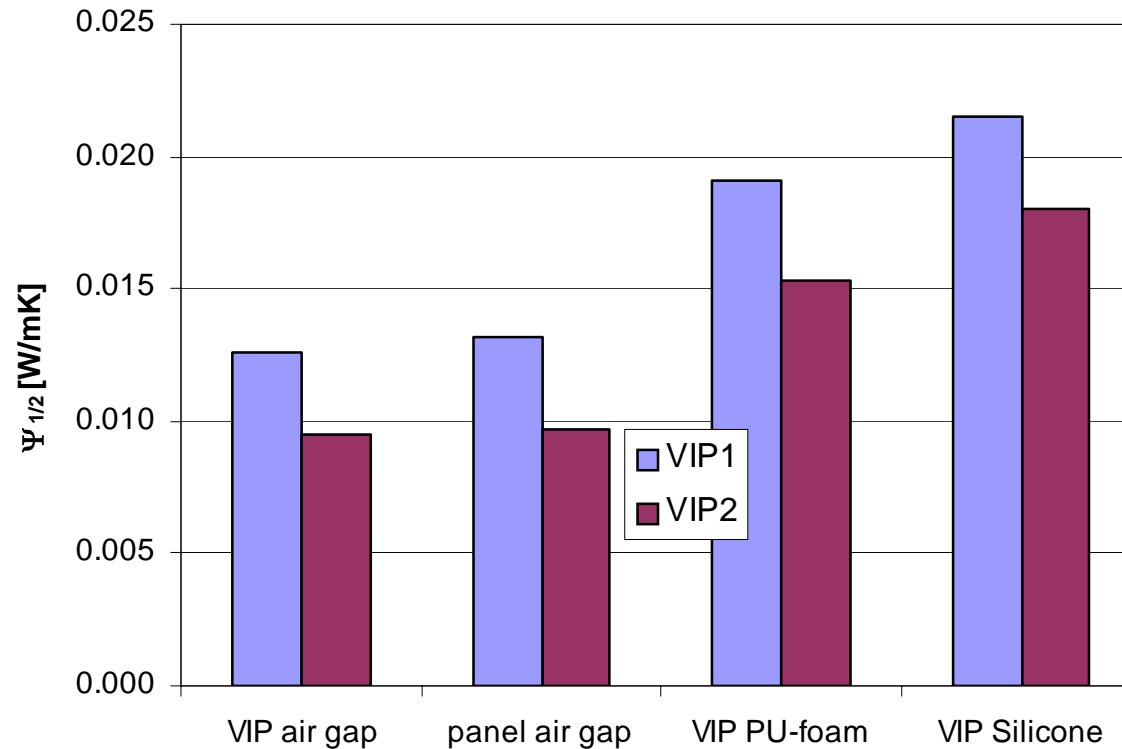
Basic systems A and B for encapsulating VIP in polystyrene foam EPS



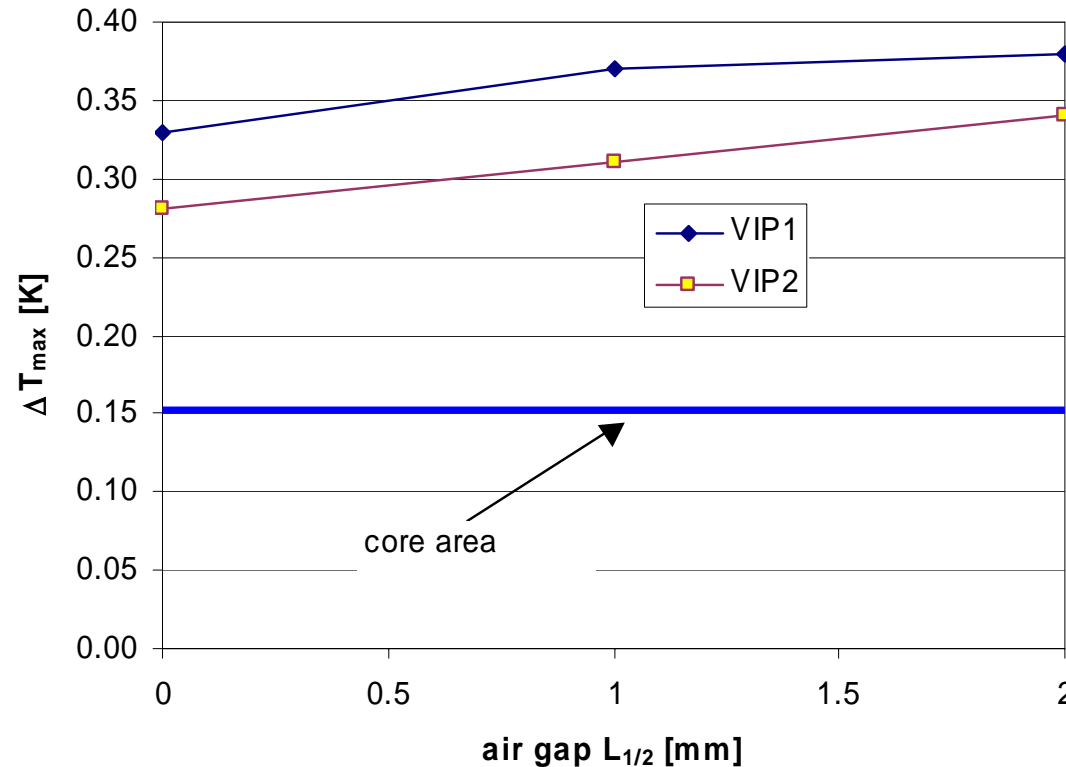
# Simulation - effect of air gaps for system B



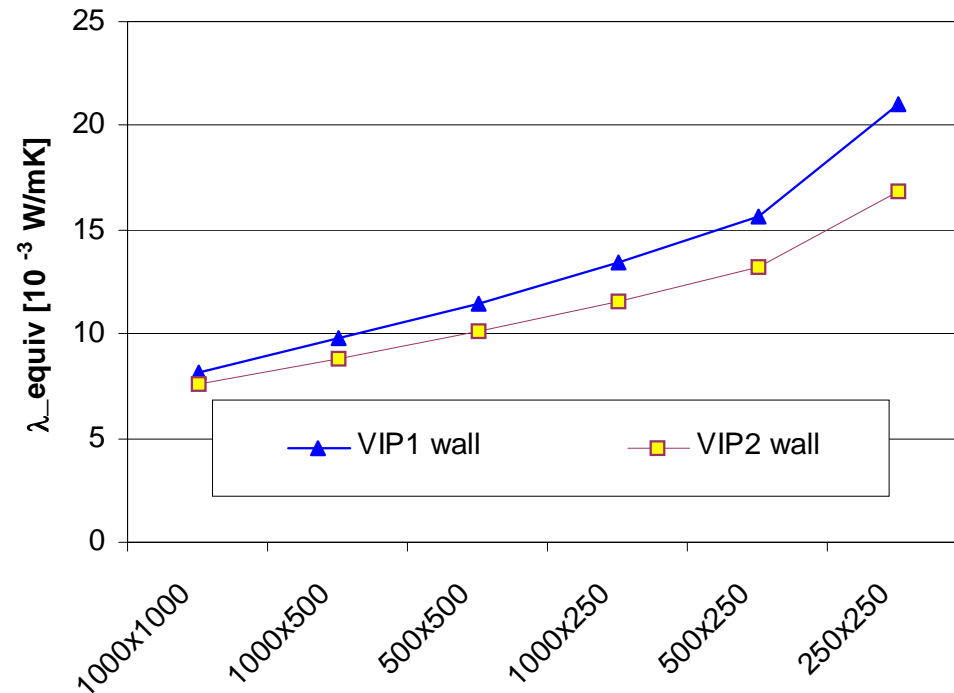
# Simulation - effect of closing air gaps 2x2mm



# Surface temperature variations - outside air temperature 0°C



# Equivalent conductivity of VIP-panel in EWIS - size dependance

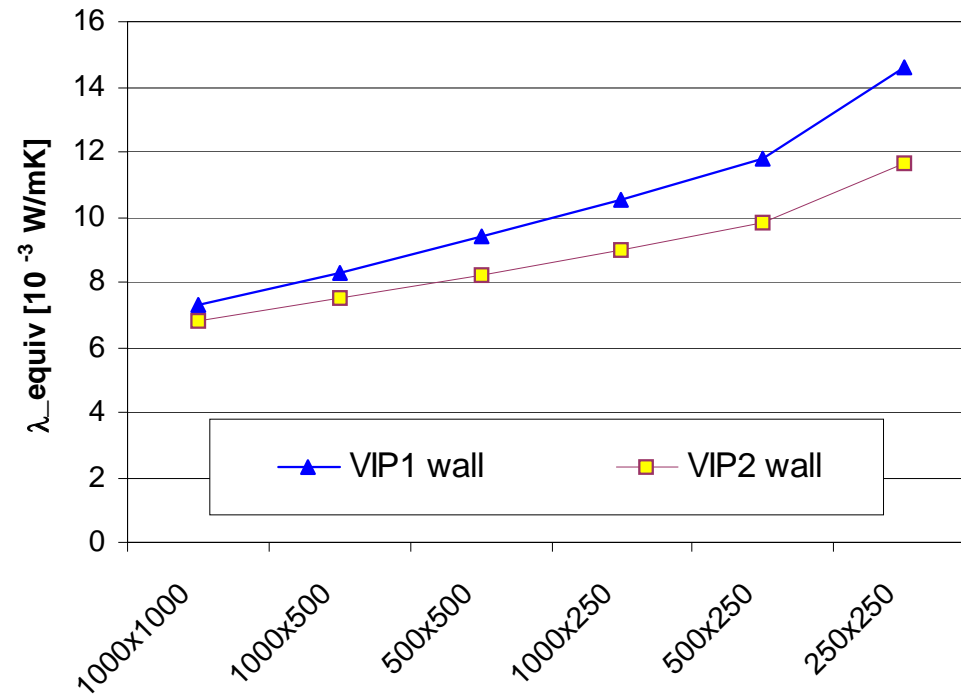


Air gap filled  
with PU-foam





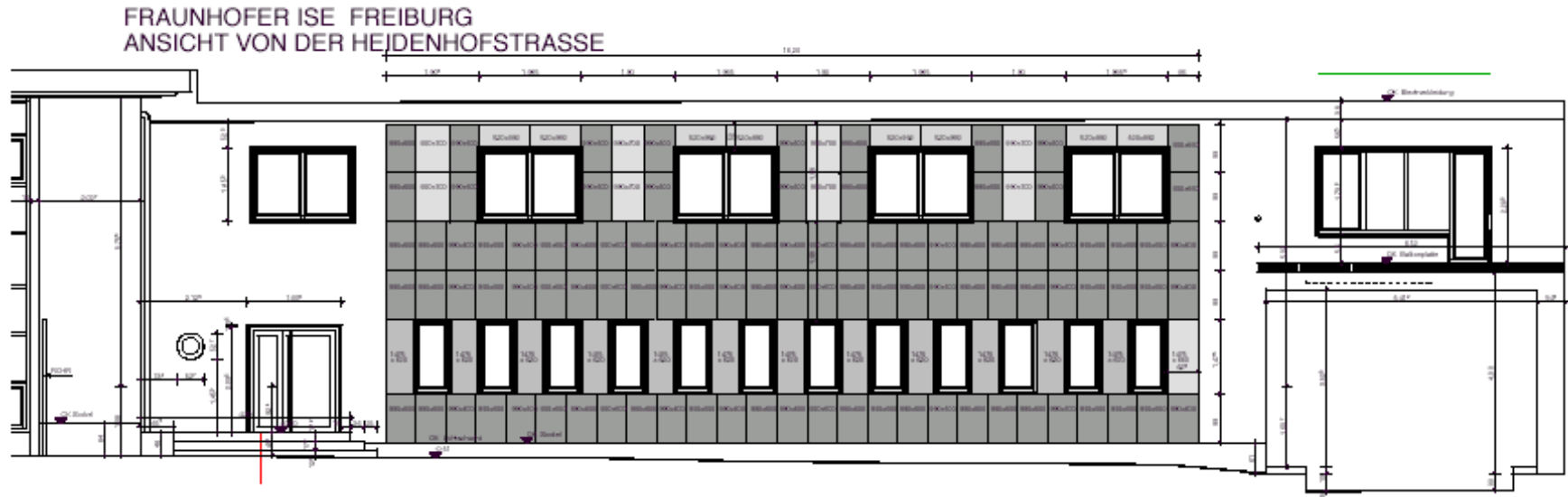
# Equivalent conductivity of VIP-panel in EWIS - size dependance



Air gap filled  
with foamed  
rubber



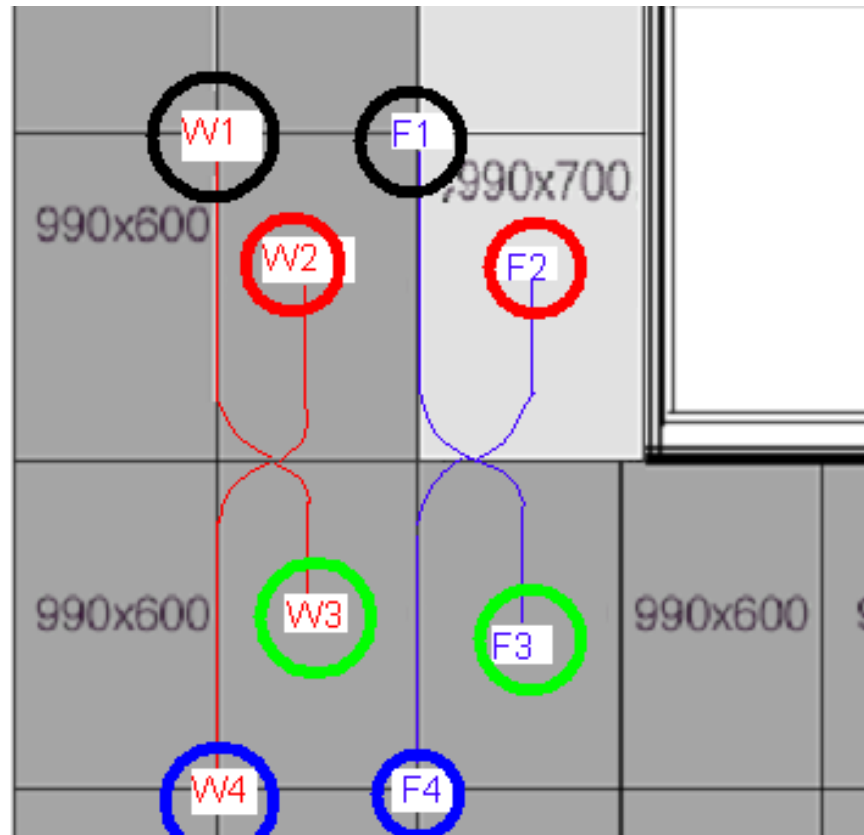
# Planning of demonstration facade



# Ultraslim prototype facade



# Monitoring of facade



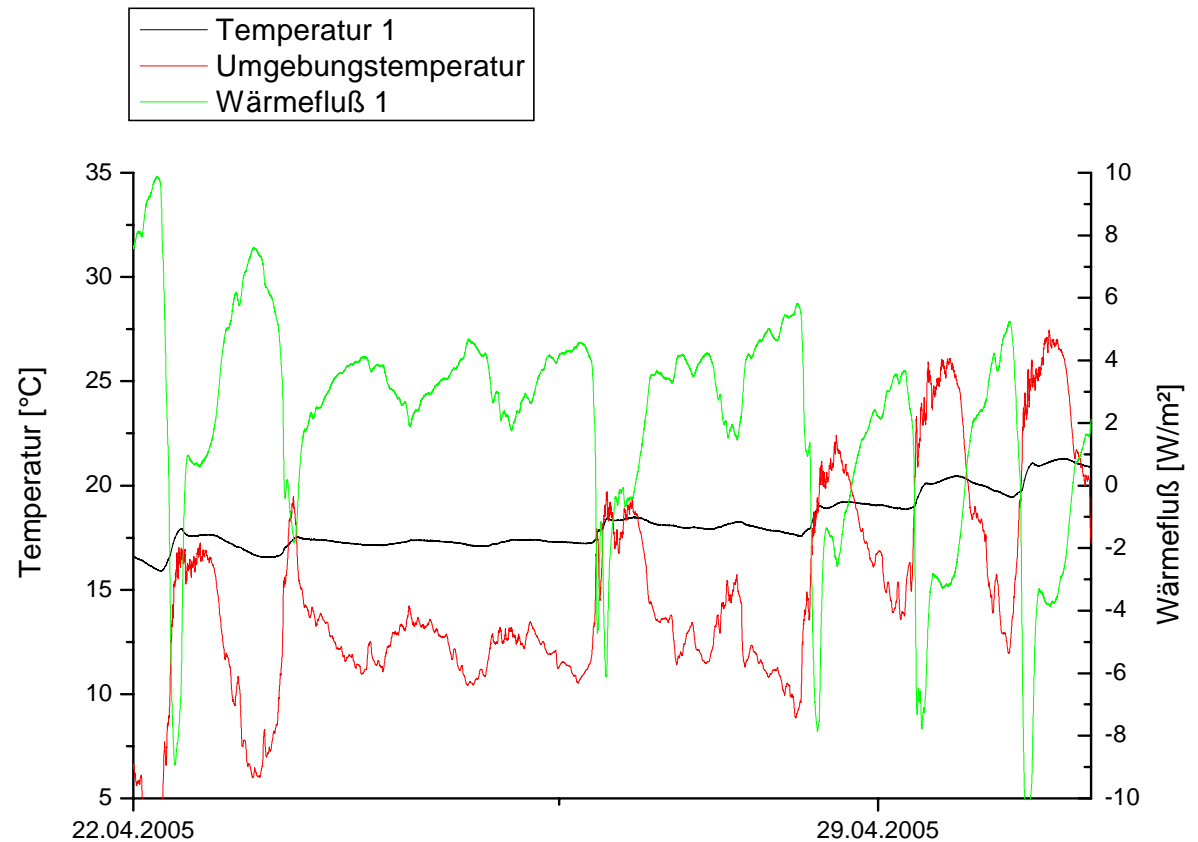
# Monitoring of facade

Position between  
VIPs

Heat flux

Contact temperature

Ambient temperature



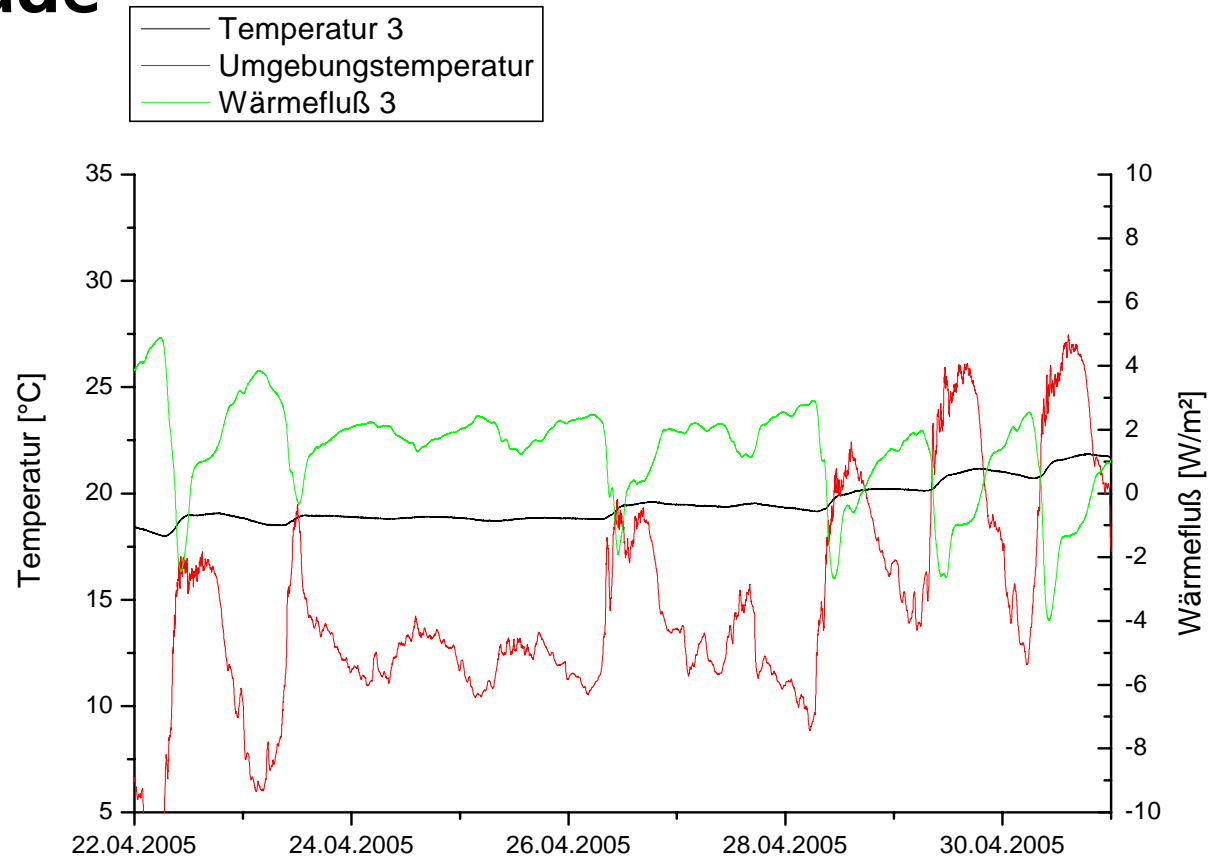
# Monitoring of facade

Centre position

Heat flux

Contact temperature

Ambient temperature



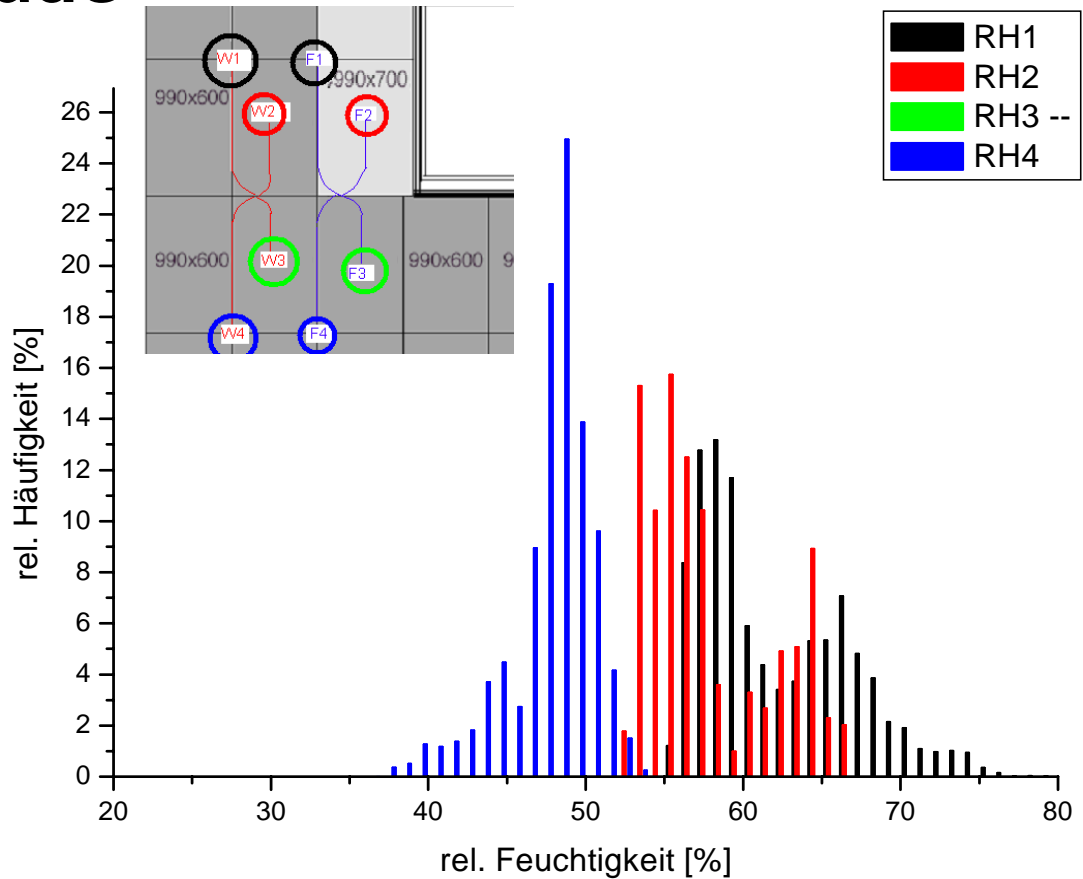
# Monitoring of facade

Humidity behind  
VIP

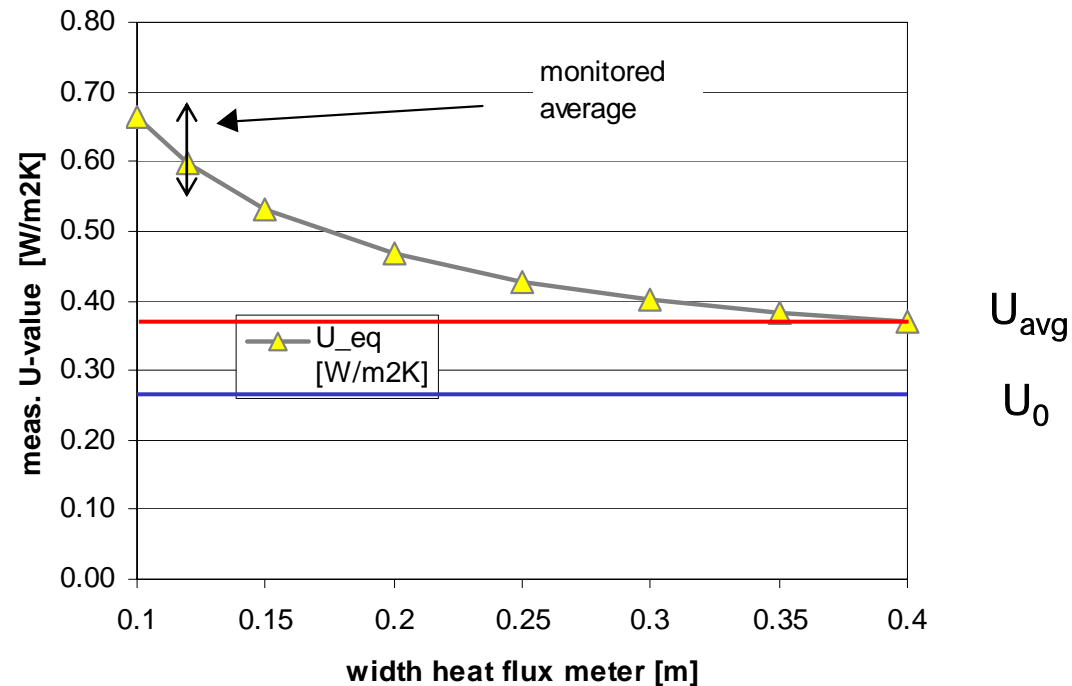
Edge heated wall

Edge unheated wall

Centre unheated wall



# Size effect of heat flux meter measurement





## Summary

- Barrier film development encountered difficulties  
potential improvement over state of the art considerable
- Prototype panels have been measured and simulated  
consistently - considerable impact of gaps
- Exterior wall systems have been designed, simulated and  
monitored - reduction of thermal bridges needed



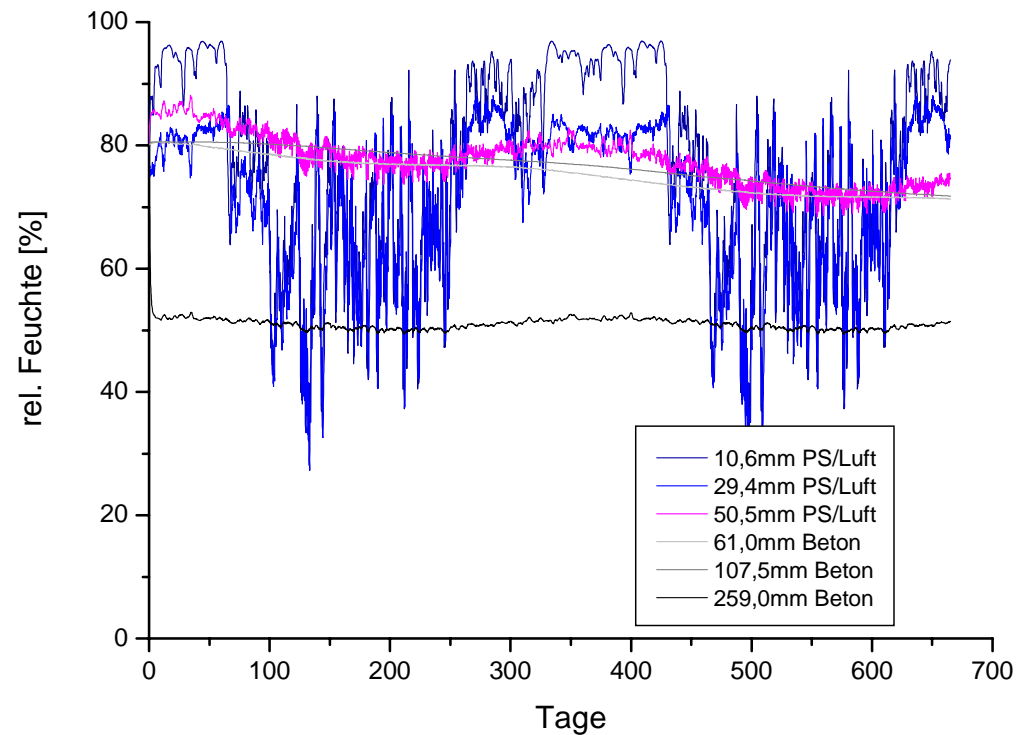
# Acknowledgements

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The work was performed in cooperation with the companies Porextherm, Sto and Wipak.

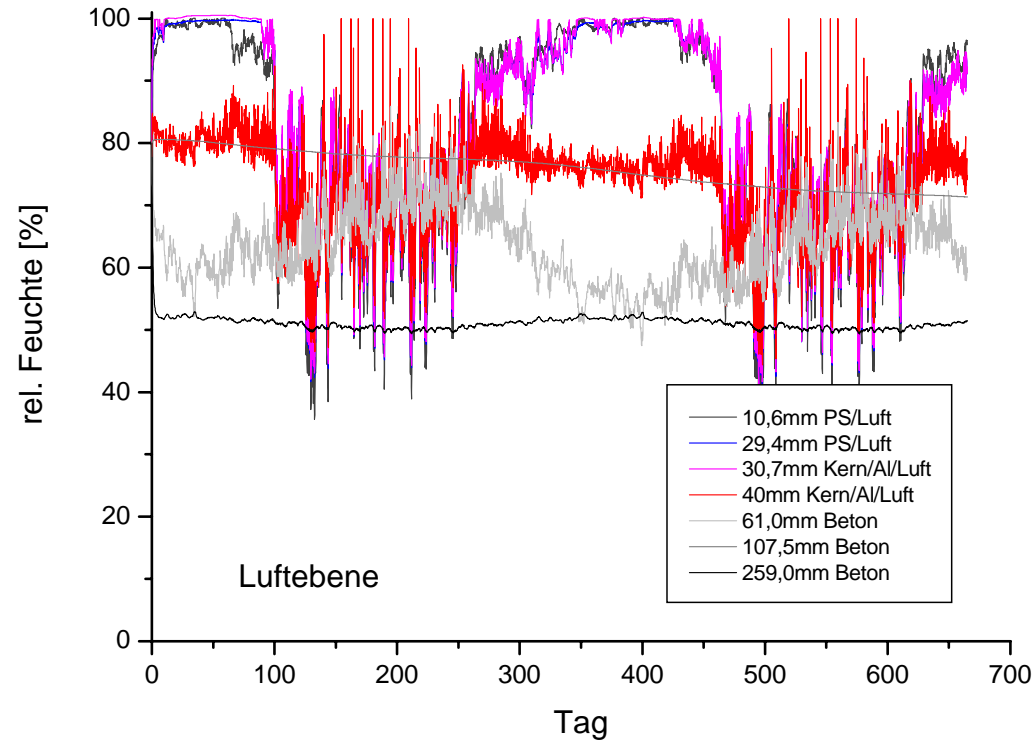




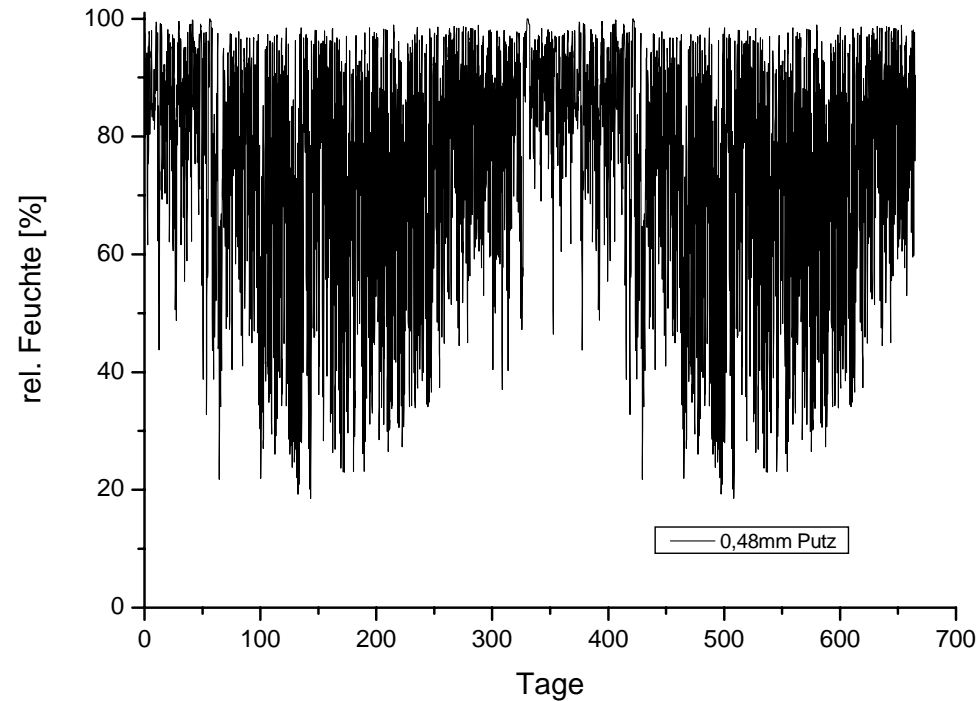
# Humidity simulation - central region



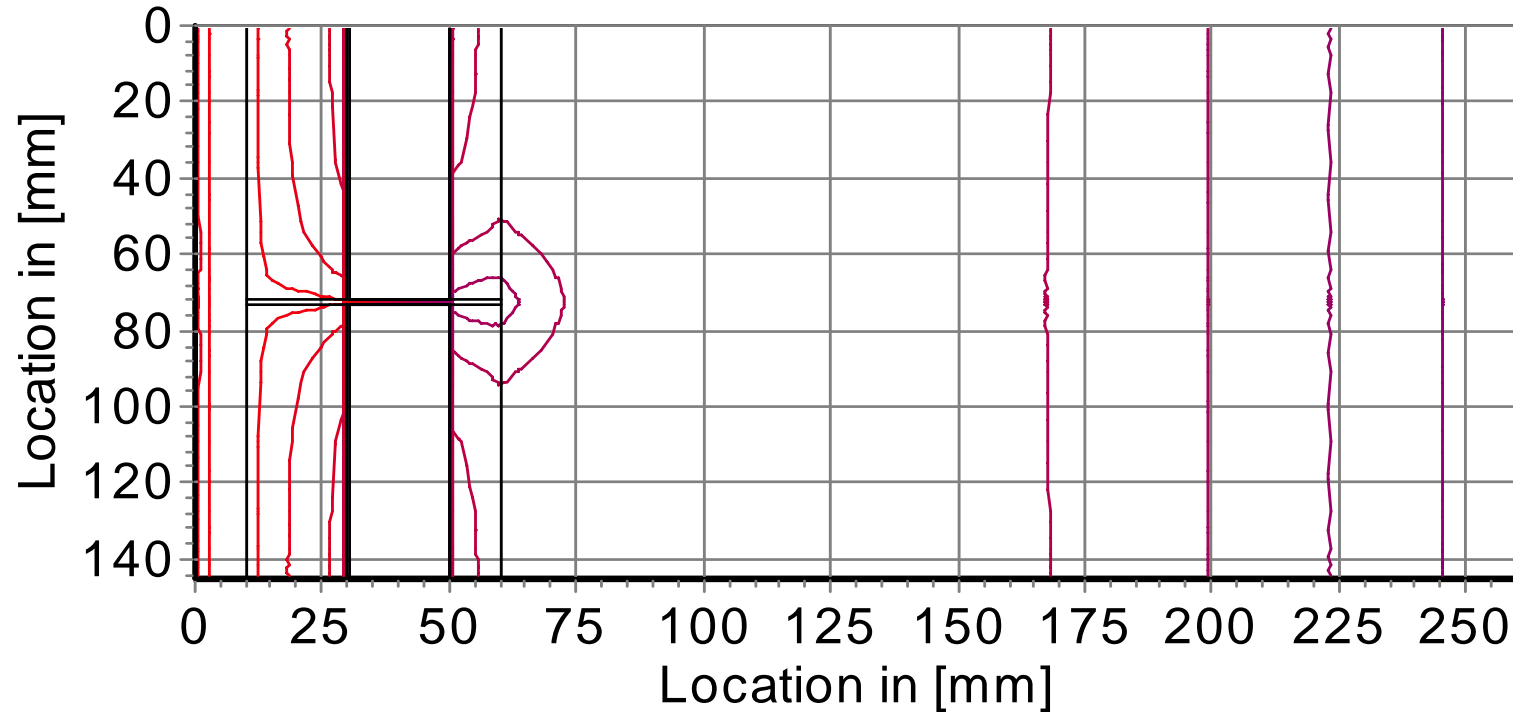
# Humidity simulation - gap region



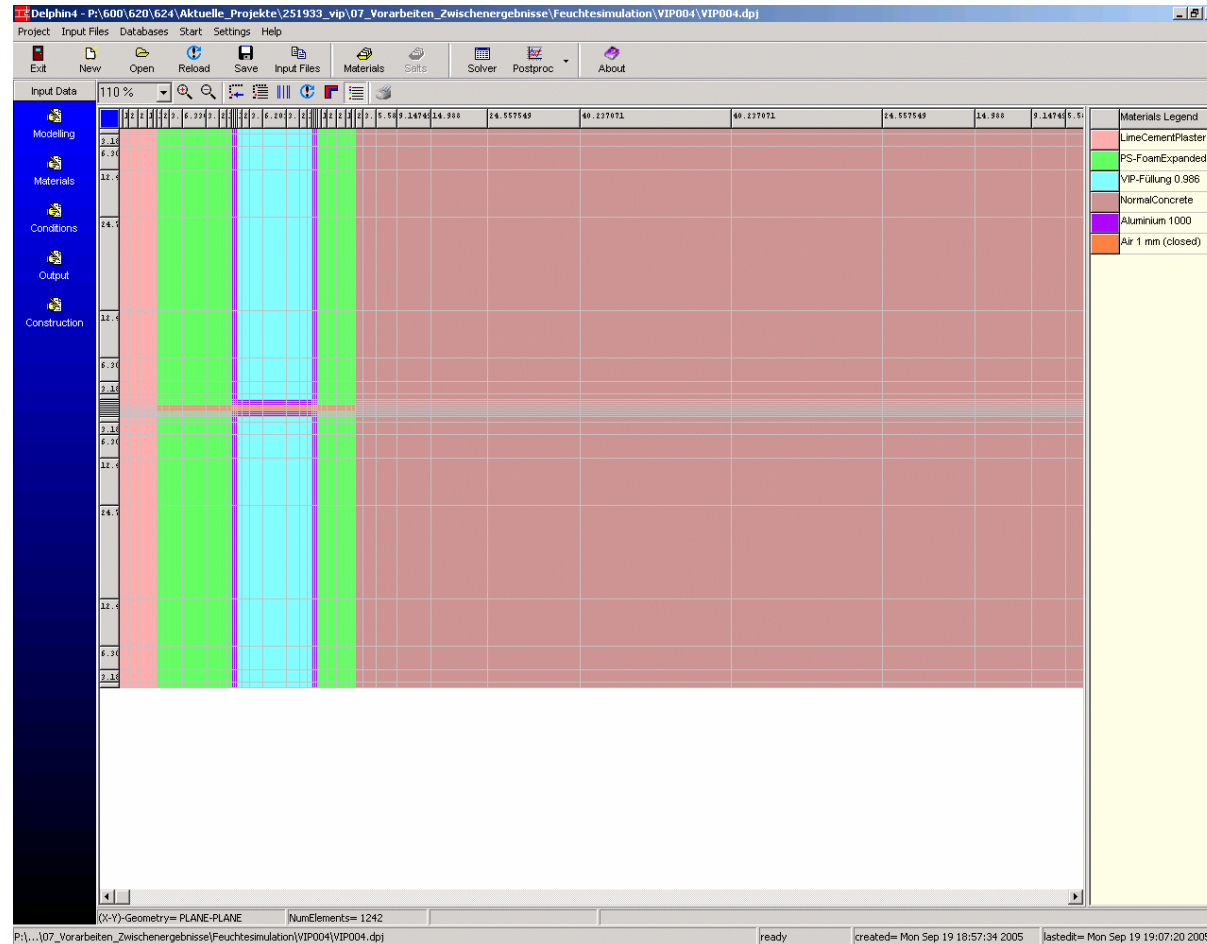
# Humidity simulation - exterior layer



# Humidity simulation - distribution



# Humidity simulation using DELPHIN software





# New design of VIP-EWIS system

Thermal bridge reduced to zero

